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U.S. Department of Commerce, Patent and Trademark Office						Do	cket N	o		Serial No.		
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INFORMATION DISCLOSURE STATEMENT BY APPLICANT						Applicant(s)						
PE (Use several sheets if necessary)						Yi Ding						
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Exactiner		Document	_							Filing		
Initial ·	+	Number	Date	Name		_ <u>C</u>	lass	Subc	lass	If Appro	priate	!
1112	AA	5,402,371	28 Mar. 1995	Ono	$\dashv$	_			<del>-</del>			,
_	AB	5,856,943	5 Jan. 1999	Jenq		-			_	<u> </u>		
	AC	5,901,084	4 May 1999	Ohnakado				•	$\perp$			
	AD	6,057,575	2 May 2000	Jenq					$\perp$		<u> </u>	
	AE	6,130,129	10 Oct. 2000	Chen								
	AF	6,134,144	17 Oct. 2000	Lin et al.								
	AG	. 6,171,909	9 Jan. 2001	Ding et al.					T			
	АН	6,200,856	13 Mar. 2001	Chen					T			٠
	AI	6,261,83693	17 Jul. 2001	Chang et al.					İ			om, 20 /
	AJ	6,266,278	24 Jul. 2001	Harari et al.					İ			10"
	AK	6,326,661	4 Dec. 2001	Dormans et al.					İ		•	
	AL	6,355,524	12 Mar. 2002	Tuan et al.								
	AM	6,365,457	2 Apr. 2002	Choi		7			T			
	AN	6,414,872	2 Jul. 2002	Bergemont et al		1			T			
	AO	6,420,231	16 Jul. 2002	Harari et al.		1						
	AP	6,437,360	20 Aug. 2002	Cho et al.		1						
	AQ	6,438,036	20 Aug. 2002	Seki et al.		٦						
	AR	6,486,023	26 Noc. 2002	Nagata		$\neg$						
	AS	6,518,618	11 Feb. 2003	Fazio et al.								
	AT	6,541,324	1 Apr. 2003	Wang								
	AU	6,541,829	1 Apr. 2003	Nishinohara et a								
	AV	2002/0064071 A1	30 May 2002	Takahashi et al.								•
1	AW	2002/0197888 A1	26 Dec. 2002	Huang et al.					T			
	AX	2003/0218908 A1	27 Nov. 2003	Park et al.					1			
1119	AX	2004/0004863 A1	8 Jan. 2004	Wang	寸	_			+			
xaminer		aden	Date Considere	d 06/2	1/-	. 2		<u> </u>				1

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